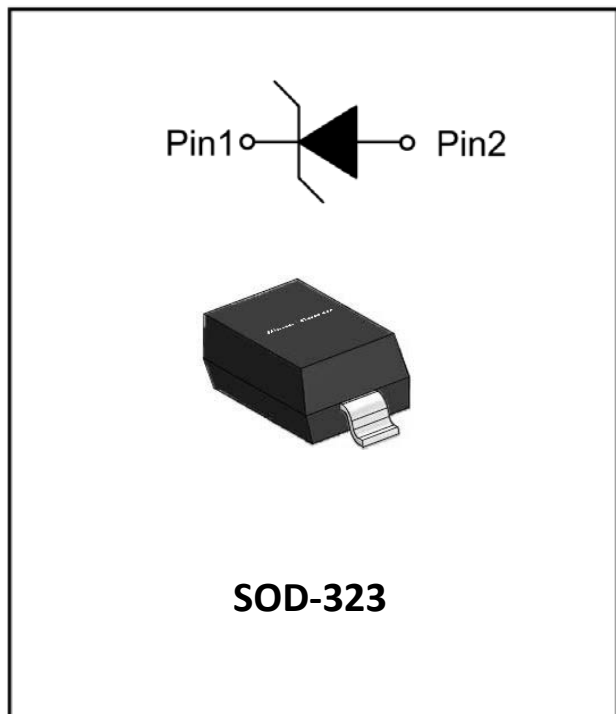


## 1- Line, Uni-directional, Transient Voltage Suppressor



### Features

- Stand-off voltage: 8V Max
- Transient protection for each line according to  
IEC61000-4-2(ESD):  $\pm 8\text{kV}$  (contact)  
IEC61000-4-5(surge): 26A (8/20 $\mu\text{s}$ )
- Low leakage current:
- Ultra low clamping voltage
- Compliant

### Applications

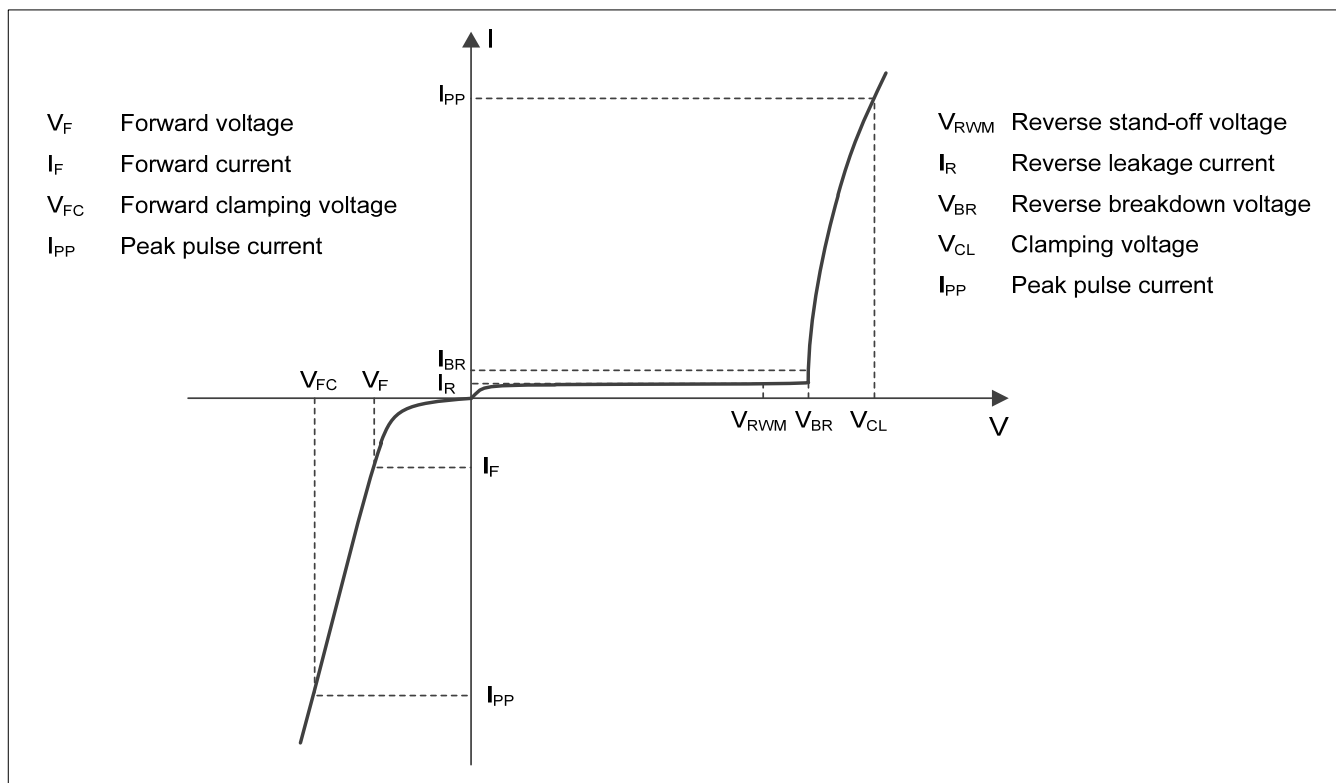
- Cellular Handsets and Accessories
- Personal Digital Assistants
- Notebooks and Handhelds
- Portable Instrumentation
- Digital Cameras
- Peripherals
- Audio Players

### Mechanical Data

- Package: SOD-323
- Lead Finish: Matte Tin
- Case Material: "Green" Molding Compound
- Moisture Sensitivity: Level 1 per J-STD-020
- Marking Information: See Below



### ■Definitions of electrical characteristics



## ■Maximum Ratings

| PARAMETER                                       | SYMBOL    | LIMITS   | UNIT |
|-------------------------------------------------|-----------|----------|------|
| Peak pulse power ( $t_p = 8/20\mu s$ )          | $P_{pk}$  | 442      | W    |
| Peak pulse current ( $t_p = 8/20\mu s$ )        | $I_{PP}$  | 26       | A    |
| ESD according to IEC61000-4-2 air discharge     | $V_{ESD}$ | $\pm 30$ | KV   |
| ESD according to IEC61000-4-2 contact discharge |           | $\pm 30$ |      |
| Junction temperature                            | $T_J$     | -55~125  | °C   |
| Storage temperature                             | $T_{STG}$ | -55~150  | °C   |

## ■Electrical Characteristics ( $T_a=25^\circ C$ Unless otherwise specified)

| PARAMETER                       | Symbol    | UNIT    | Conditions                      | Min | Typ | Max |
|---------------------------------|-----------|---------|---------------------------------|-----|-----|-----|
| Reverse maximum working voltage | $V_{RWM}$ | V       |                                 |     |     | 8   |
| Reverse leakage current         | $I_R$     | $\mu A$ | $V_{RWM} = 8V$                  |     |     | 0.6 |
| Reverse breakdown voltage       | $V_{BR}$  | V       | $I_{BR} = 1mA$                  | 8   |     | 12  |
| Clamping voltage <sup>2)</sup>  | $V_{CL}$  | V       | $I_{PP} = 1A, t_p = 8/20\mu s$  |     |     | 12  |
|                                 |           | V       | $I_{PP} = 26A, t_p = 8/20\mu s$ |     |     | 17  |
| Junction capacitance            | $C_J$     | pF      | $V_R = 0V, f = 1MHz$            |     | 126 |     |

Notes:

- (1). TLP parameter:  $Z_0 = 50\Omega$ ,  $t_p = 100ns$ ,  $t_r = 2ns$ , averaging window from 60ns to 80ns.  $R_{DYN}$  is calculated from 4A to 16A.
- (2). Non-repetitive current pulse, according to IEC61000-4-5.

## ■Ordering Information (Example)

| PREFERRED P/N | PACKING CODE | UNIT WEIGHT(mg) | MINIMUM PACKAGE(pcs) | INNER BOX QUANTITY(pcs) | OUTER CARTON QUANTITY(pcs) | DELIVERY MODE |
|---------------|--------------|-----------------|----------------------|-------------------------|----------------------------|---------------|
| ESD8V0D3      | F2           | Approximate 4   | 3000                 | 30000                   | 120000                     | 7 reel        |

## ■ Characteristics (Typical)

Fig.1 8/20 $\mu$ s waveform per IEC61000-4-5

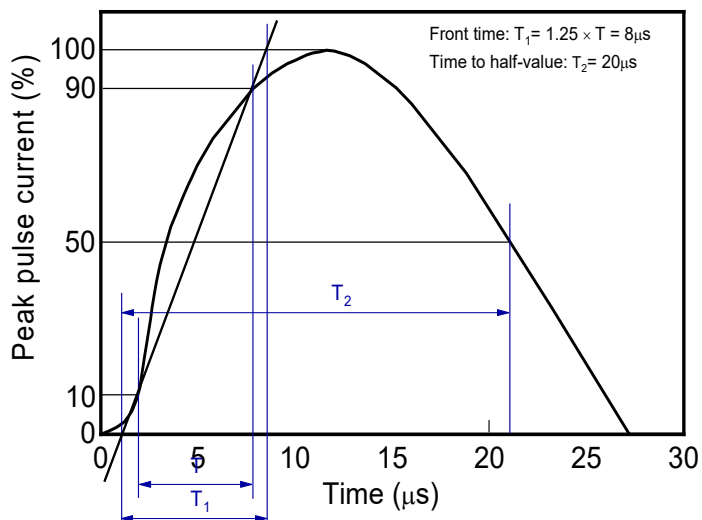


Fig.2 Contact discharge current waveform per IEC61000-4-2

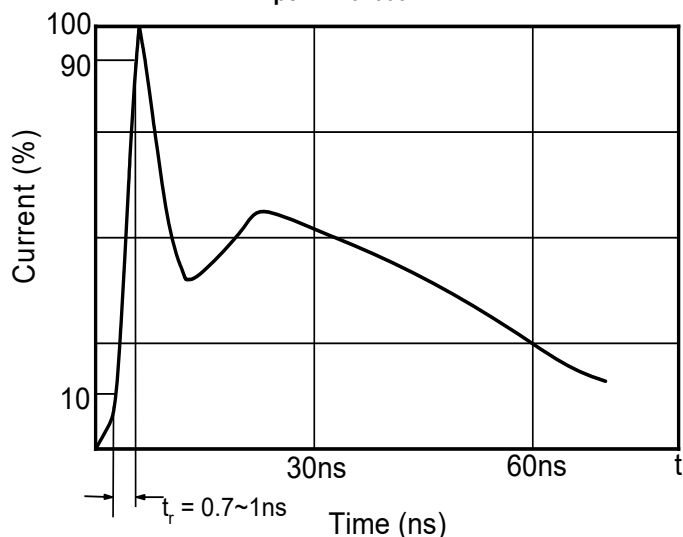


Fig.3 Clamping voltage vs. Peak pulse current

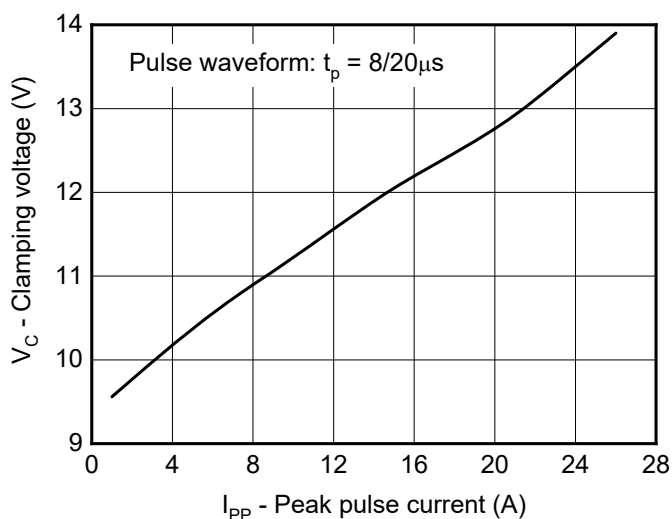


Fig.4 Capacitance vs. Reverse voltage

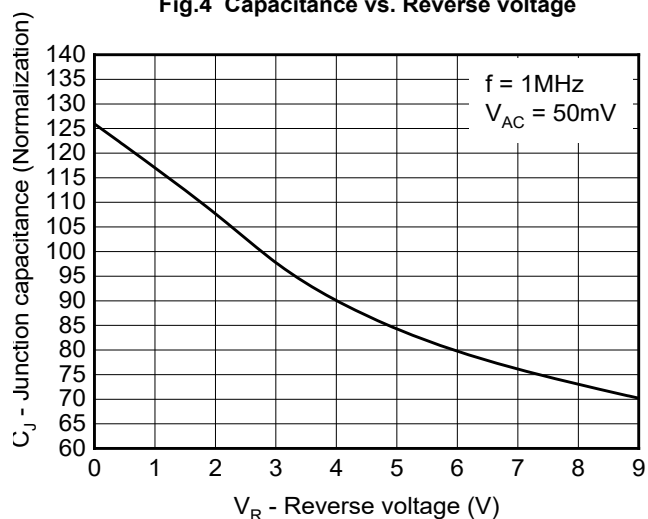


Fig.5 Non-repetitive peak pulse power vs. Pulse time

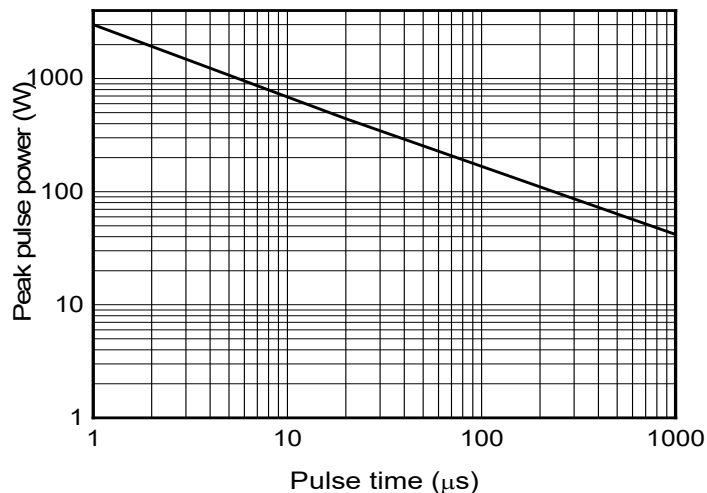


Fig.6 Power derating vs. Ambient temperature

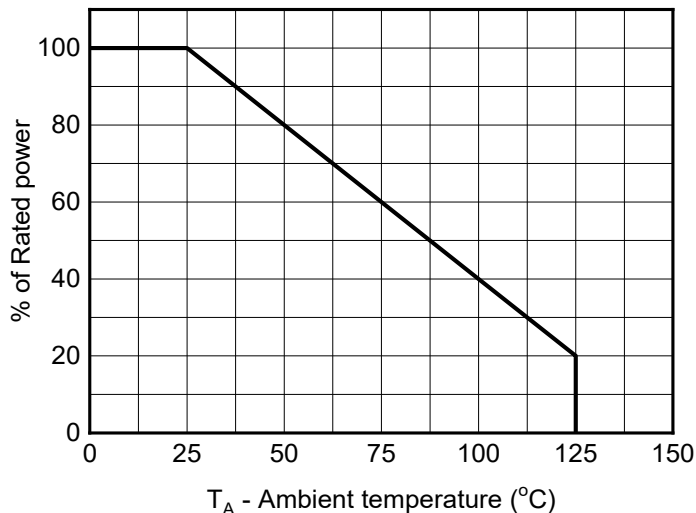
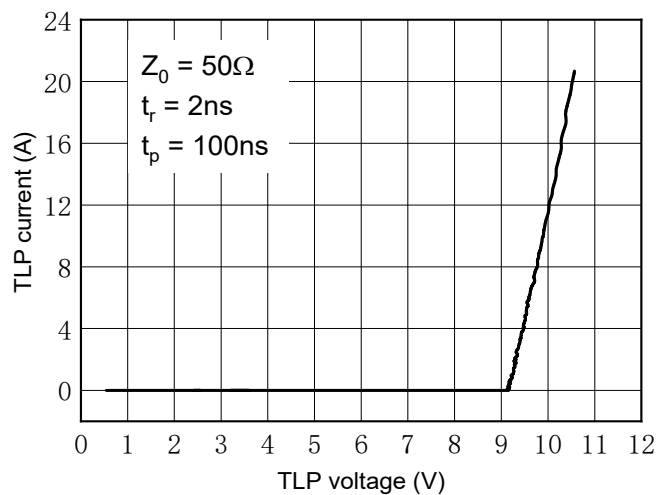
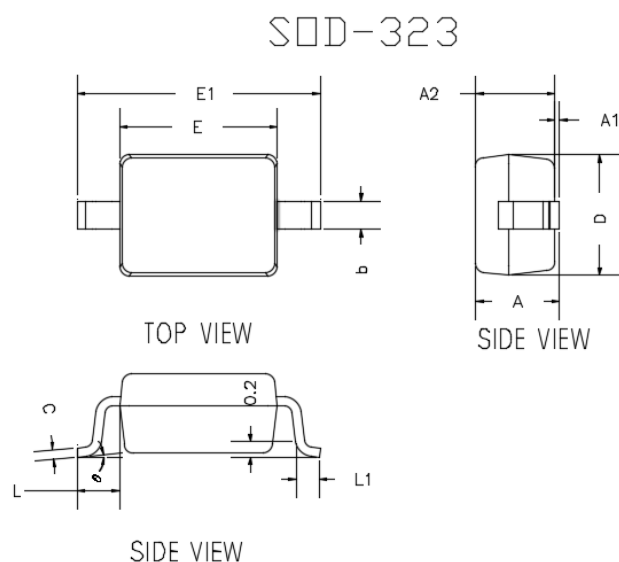


Fig.7 TLP Measurement

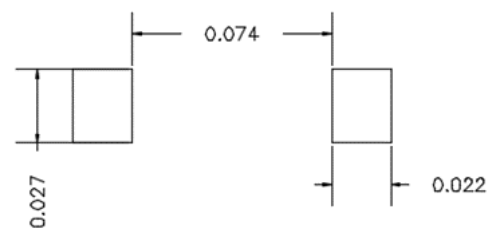


## ■ Outline Dimensions



| DIMENSIONS |           |        |          |        |
|------------|-----------|--------|----------|--------|
| DIM        | INCHES    |        | MM       |        |
|            | MIN       | MAX    | MIN      | MAX    |
| A          | ---       | 0.0393 | ---      | 1.0000 |
| A1         | 0.0000    | 0.0039 | 0.0000   | 0.1000 |
| A2         | 0.0314    | 0.0354 | 0.8000   | 0.9000 |
| b          | 0.0098    | 0.0157 | 0.2500   | 0.4000 |
| c          | 0.0031    | 0.0059 | 0.0800   | 0.1500 |
| D          | 0.0472    | 0.0551 | 1.2000   | 1.4000 |
| E          | 0.0629    | 0.0709 | 1.6000   | 1.8000 |
| E1         | 0.0984    | 0.1063 | 2.5000   | 2.7000 |
| L          | 0.0187TYP |        | 0.475TYP |        |
| L1         | 0.0098    | 0.0157 | 0.250    | 0.400  |
| θ          | 0°        | 8°     | 0°       | 8°     |

## ■ Soldering Footprint



UNIT: inch

SUGGESTED SOLDER PAD LAYOUT

**Disclaimer**

The information presented in this document is for reference only. Shanghai Sunco Electronics Co., Ltd. reserves the right to make changes without notice for the specification of the products displayed herein to improve reliability, function or design or otherwise.

The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), Russiansunco or anyone on its behalf, assumes no responsibility or liability for any damages resulting from such improper use of sale.

This publication supersedes & replaces all information previously supplied. For additional information, please visit our website [http:// www.russiansunco.com](http://www.russiansunco.com) , or consult your nearest Russiansunco's sales office for further assistance.